ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.:	SPCH022B
DEPT.	For 2.00 mm (.079") Pin Header of System CH74	PAGE:	1/3

1. SCOPE:

This specification contains the test requirement of subject pin headers when tested under the condition and

below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

MIL - STD - 202 Methods for test of connectors for electronic equipment

MIL - STD - 202

MIL - STD - 1344

Test methods for electrical connectors

JIS - C - 5402 Methods for test of connectors for electronic equipment

UL 94 Test for flammability of plastic materials for parts in devices and

appliance

3. APPLICABLE SERIES NO.: CH74 SERIES

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

(P.C. Board on which the Pin Header are installed), 0.8 mm (.031") ~ 1.6 mm (.063")



REVIEWED: <u>Alex</u> APPROVED: <u>David</u> VERIFIED: <u>Sun</u>.



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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	
7.1	Rated current and voltage		1A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max., 100 mA max.	Less than 20 m Ω
7.3	Dielectric strength	When applied AC 1000 V 1minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than $1000 \text{M}\Omega$

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Pin retention force	Push pin from insulator base at speed	0.8 Kgf (7.84N)
		25± 3 mm per minute	

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Solder ability	Soldering time: 5 ± 0.5 second	Minimum:
		Soldering pot: 230 ± 5°C	90% of immersed area
9.2	Resistance to soldering heat	Insulator: Glass filled polyester UL 94V-0 Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C	No damage
		Insulator: Nylon 6T Max. Infrared Reflow Soldering temperature & time: 230°C for 60 Sec. 260°C for 10 Sec.	
9.3	Heat aging	105± 2°C, 96 hours	No damage
9.4	Humidity	40± 2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength:
9.5	Temperature cycling	One cycle consists of: (1)-55 +0 °C, 30 min. (2)Room temp. 10-15 min. (3) 85 +3 °C, 30 min. (4)Room temp. 10-15 min.	To pass para 7-3 Appearance: No damage Contact resistance: Less than twice of initial



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	ITEM	TEST CONDITION	REQUIREMENT
9.6	Salt spray	Temperature: 35± 3°C	Appearance: No damage
		Solution: 5± 1%	Contact resistance:
		Spray time: 48± 4 hours	Less than twice of initial
		Measurement must be taken after water	
		rinse	

10. AMBIENT TEMPERATURE RANGE:

-40 to + $105 \,^{\circ}\text{C}$; + $215 \,^{\circ}\text{C}$ intermittent (Vapor Phase Solder Reflow) for SMT type